



- Material:
 Insulator: LCP+30% G.F., UL 94V-0 Rated Color:Black
 Contact: Phosphor Bronze , 0.25t
- Plating:
 Contact Area:Gold plating over 50u"Nickel underplating.
 Soldering Zone: 100%TIN over 50u" min. Ni underplate overall.
 Au Contact Area:10u" Gold Plating.
- Inspection Dimension: ■ Critical
- Note: 4.This soldering pad is optional and shall be grounding.
- Insertion Force:15N max
 Extraction Force:0.15N min
 Card Retention Force: 688g max. Avrg: 543g.
- Operating temperature -40~+85 °C
 Storage temperature -40 ~+85 °C

PRODUCT NUMBER:
 104G-T A A 0-R
 1 2 3 4

- Type
T:Top Mount
- Contact Plating
A:10u"Gold Plating
- Stand Off
A:0mm
- RoHS

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REV.	DESCRIPTION	DATE	REV.	DESCRIPTION	DATE	SIZE	REV.	FILE NAME
1	Revise: Shell dimensions, add datecode	2016/08/30	4			A4	1.0	104G-TAA0-R_B_7
2	Revise: Shell dimensions	2014/09/18	5					
3	Revise: ATTEND logo	2013/07/02	6					
4	Revise: Temperature specifications	2013/05/02	7					
5	Revise: Brand identity	2012/08/03	8					
6	Revise: Pin Assignment	2010/01/19	9					
7	Revise: Drawing release	2009/12/29	10					

ATTEND
 www.attend.com.tw

DRAWN NAME:
 SD Socket Top Mount, Push-Push Type
 With Card Lock Function

PRODUCT NO. 104G-TAA0-R